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June 1997

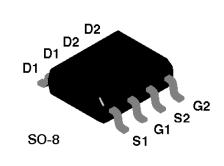


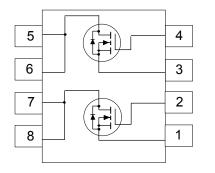
NDS8936 Dual N-Channel Enhancement Mode Field Effect Transistor

General Description

Features

- These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.
- 5.3A, 30V. $R_{DS(ON)} = 0.035\Omega @ V_{GS} = 10V$ $R_{DS(ON)} = 0.05\Omega @ V_{GS} = 4.5V.$
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.
- Dual MOSFET in surface mount package.



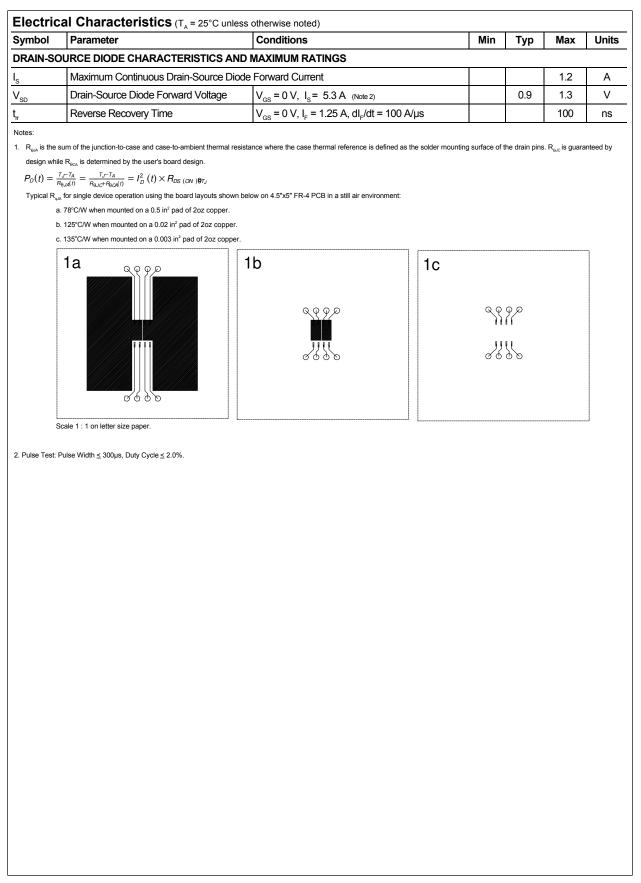


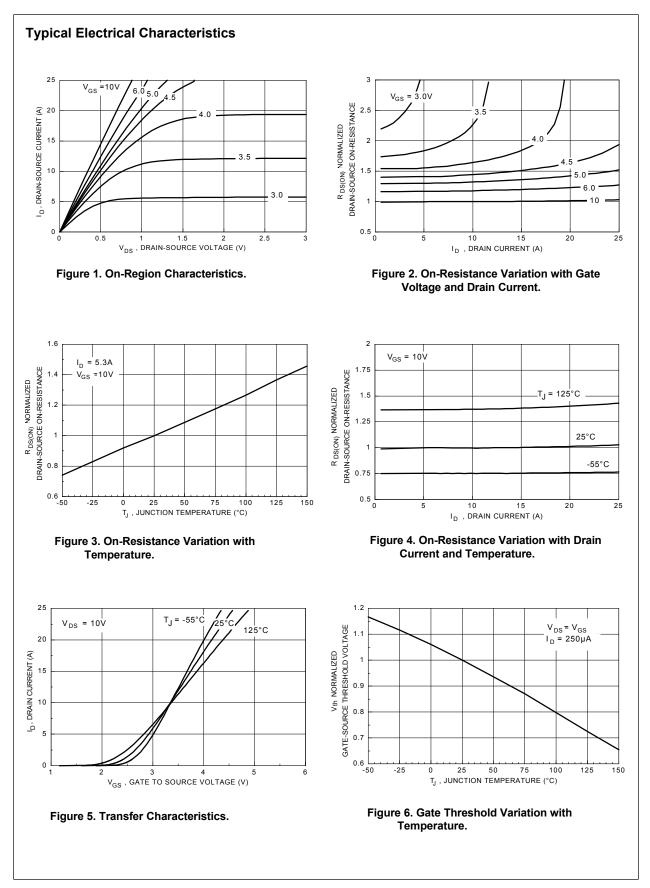
Absolute Maximum Ratings T_A= 25°C unless otherwise noted

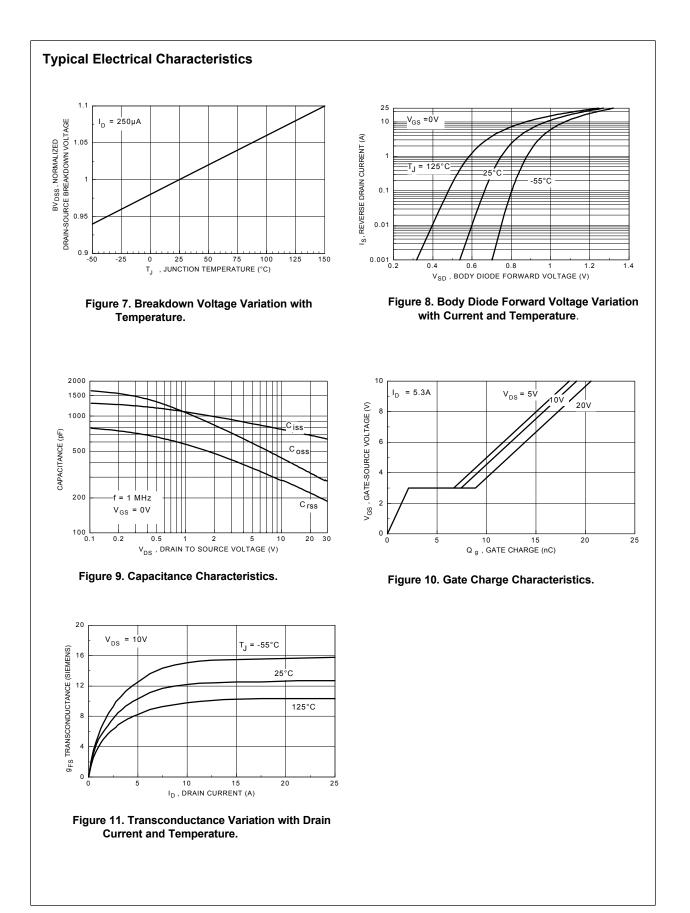
Symbol	Parameter	NDS8936	Units	
V _{DSS}	Drain-Source Voltage	30	V	
V _{GSS}	Gate-Source Voltage	± 20	V	
I _D	Drain Current - Continuous (Note 1a)	± 5.3	А	
	- Pulsed	± 20		
P _D	Power Dissipation for Dual Operation	2	W	
	Power Dissipation for Single Operation (Note 1a)	1.6		
	(Note 1b)	1		
	(Note 1c)	0.9		
T_,T _{stg}	Operating and Storage Temperature Range	-55 to 150	°C	
THERMA	L CHARACTERISTICS			
R _{eja}	Thermal Resistance, Junction-to-Ambient (Note 1a)	78	°C/W	
R _{ejc}	Thermal Resistance, Junction-to-Case (Note 1)	40	°C/W	

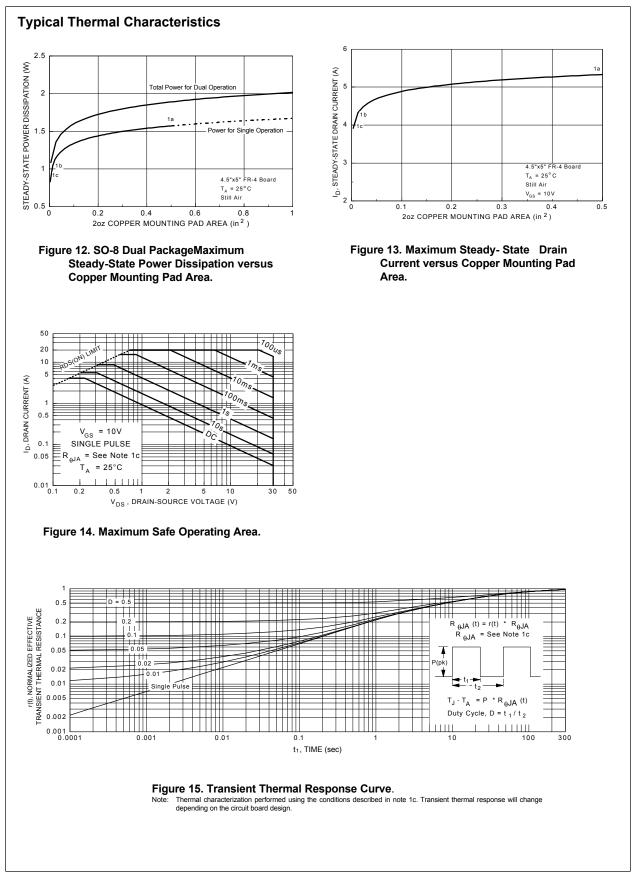
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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA		30			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$	_			1	μA
			T _J = 55°C			10	μA
I _{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	-			100	nA
I _{GSSR}	Gate - Body Leakage, Reverse	V _{GS} = -20 V, V _{DS} = 0 V				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		1	1.6	2.8	V
			T _J = 125°C	0.7	1.2	2.2	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.3 \text{ A}$			0.033	0.035	Ω
			T _J = 125°C		0.046	0.063	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 4.4 \text{ A}$			0.046	0.05	
			T _J = 125°C		0.064	0.09	
I _{D(on)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 5 V		20			Α
		$V_{GS} = 4.5 V, V_{DS} = 5 V$		10			
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5.3 \text{ A}$			10.5		S
DYNAMIC	CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$ f = 1.0 MHz			720		pF
C _{oss}	Output Capacitance	f = 1.0 MHz			370		pF
C _{rss}	Reverse Transfer Capacitance				250		pF
SWITCHI	NG CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GEN} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			12	20	ns
ţ	Turn - On Rise Time				13	30	ns
t _{D(off)}	Turn - Off Delay Time				29	50	ns
t,	Turn - Off Fall Time				10	20	ns
Q _g	Total Gate Charge	$\frac{V_{DS} = 10 \text{ V},}{I_D = 5.3 \text{ A}, \text{ V}_{GS} = 10 \text{ V}}$			19	30	nC
Q _{gs}	Gate-Source Charge				2.2		nC
Q _{gd}	Gate-Drain Charge				5.5		nC









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Definition of Terms

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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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